General Description

The SJMC023N04 uses SGT technology to provide excellent R_{DS(ON)}, low gate charge and fast switching characteristics. This device is suitable for use as a wide variety of applications.

Features

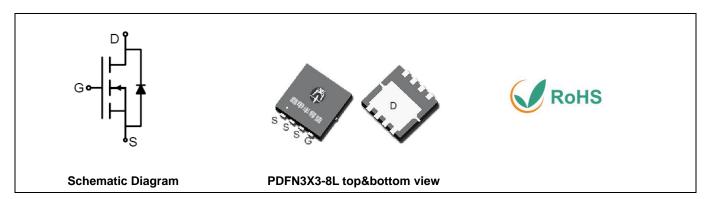
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

- Load switch
- PWM applications
- Power management

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	40	V
R _{DS(ON)_TYP}	1.6	mΩ
I _D	151	А
Q _G	36	nC



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Pcaking	Reel Size	Tape width	Quantity
SJMC023N04	C023N04	PDFN3*3-8L	Tape	\	\	5000 Pcs

Table 1. Absolute Maximum Ratings (T_C=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit	
V _{DS}	Drain-Source Voltage (Vcs=0V) 40		V	
V _{GS}	Gate-Source Voltage (V _{DS} =0V) ±20		V	
l-	Drain Current-Continuous(Tc=25°C)		А	
I _D Drain Current-Continuous(T _C =100℃)		95	А	
I _{DM} (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	604	А	
Maximum Power Dissipation(T _C =25 °C)		78	W	
P _D	Maximum Power Dissipation(Tc=100°C)	31	W	
Eas	Avalanche energy (Note 2)	361	mJ	
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 To 150	င	

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
Rejc	Thermal Resistance, Junction-to-Case		1.6	°C/W

Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	40			V
		V _{DS} =40V, V _{GS} =0V T _J =25℃			1	μΑ
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =0V, V _{GS} =0V T _J =125℃			100	μΑ
Igss	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0		2.5	V
g FS	Forward Transconductance	V _{DS} =5V, I _D =20A		49		S
Б	D : 0 0 0 1 D : 1	V _{GS} =10V, I _D =20A T _J =25℃		1.6	2.1	mΩ
$R_{DS(ON)}$	Drain-Source On-State Resistance	V _{GS} =4.5V, I _D =20A T _J =25℃		2.2	2.9	mΩ
Dynamic Charac	cteristics					
C _{iss}	Input Capacitance	V _{DS} =20V,V _{GS} =0V, f=1.0MHz		2260		pF
Coss	Output Capacitance			916		pF
C _{rss}	Reverse Transfer Capacitance			89		pF
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		1.8		Ω
Switching Parar	meters					
t _{d(on)}	Turn-on Delay Time			6		nS
t _r	Turn-on Rise Time	V _{GS} =10V, V _{DS} =20V,		8.5		nS
t _{d(off)}	Turn-Off Delay Time	$R_L=1\Omega$, $R_{GEN}=3\Omega$		31		nS
t _f	Turn-Off Fall Time			16		nS
Q_g	Total Gate Charge			36		nC
Q _{gs}	Gate-Source Charge	V _{GS} =10V, V _{DS} =20V, I _D =20A		5		nC
Q_gd	Gate-Drain Charge			7		nC
Source-Drain Di	iode Characteristics			•		•
I _{SD}	Source-Drain Current (Body Diode)				151	Α
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =20A			1.2	V
t _{rr}	Reverse Recovery Time	I _F =20A, dI/dt=100A/μs		40		ns
Qrr	Reverse Recovery Charge	I _F =20A, dI/dt=100A/μs		28		nC
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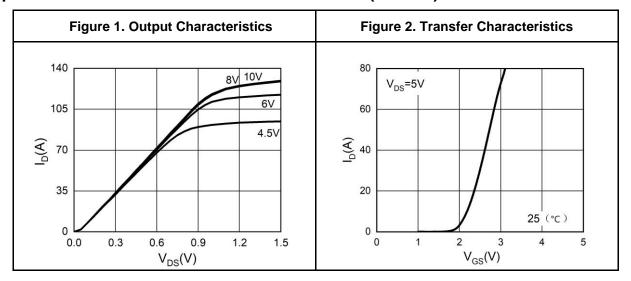
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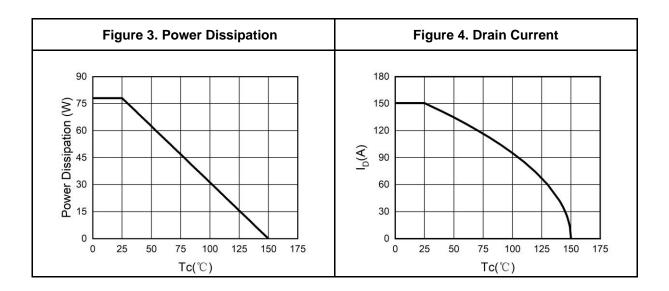
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

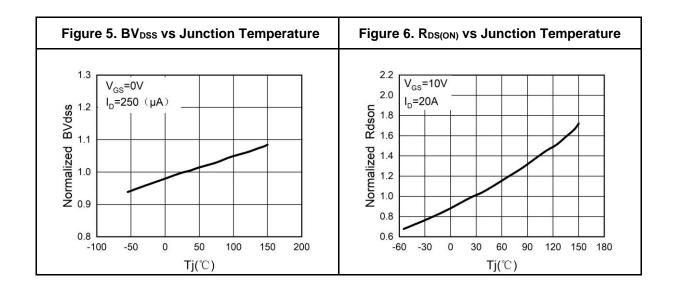
Notes 2.E_{AS} condition: T_J=25°C,V_{DD}=30V,V_G=10V, Rg=25Ω, L=0.5mH. Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



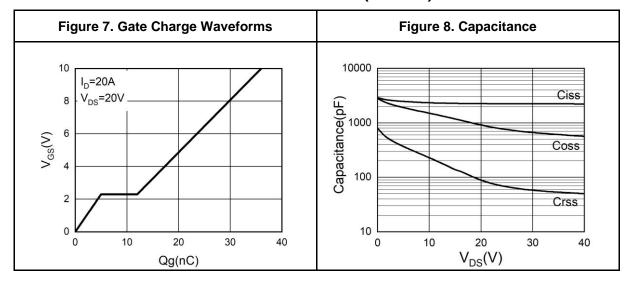
Typical Electrical And Thermal Characteristics (Curves)

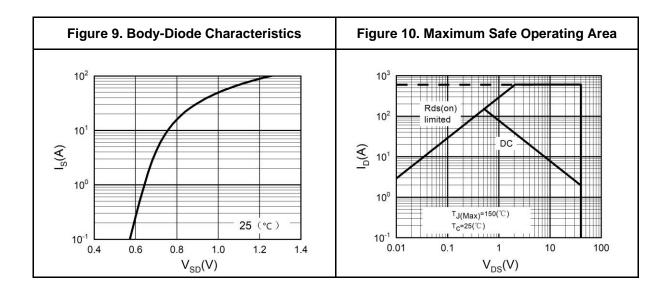




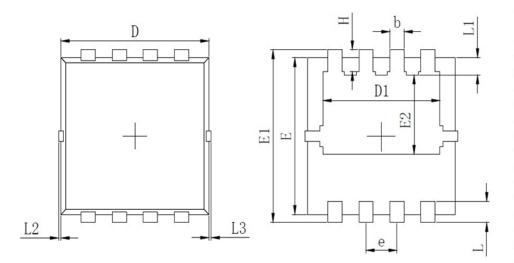


Typical Electrical And Thermal Characteristics (Curves)

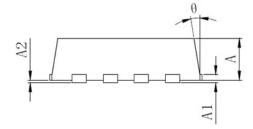




PDFN3X3-8L Package Information



SYMBOL	MILLIMETER			
SIMDUL	MIN	Typ.	MAX	
A	0.700	0.800	0.900	
A1	0.152 REF.			
A2		0~0.05		
D	3.000	3. 100	3. 200	
D1	2.300	2. 450	2.600	
E	2.900	3.000	3. 100	
E1	3. 150	3. 300	3. 450	
E2	1.320	1.520	1.720	
b	0. 200	0.300	0.400	
е	0.550	0.650	0.750	
L	0.300	0.400	0.500	
L1	0.180	0.330	0.480	
L2	0~0.100			
L3	0~0.100			
Н	0.315	0.415	0.515	
θ	8°	10°	12°	



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Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

The performances and characteristics of this product in the independent testing state are displayed in this document. Wuxi Shangjia Semiconductor can't guarantee of the performances and characteristics of this described product that mounted in the customer's products or equipments as same as that in the independent testing state. So the customer should evaluate and test devices mounted in the customer's products or equipments.

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